















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	4N65L
Overseas Part Number	4N65L
▶ Equivalent Part Number	4N65L

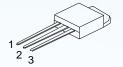




4N65L TO-251/252

MOSFET(N-Channel)



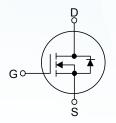


■ FEATURES

TO-252

TO-251

Robust High Voltage Terminrtion
Avalanche Energy Specified
Source-to-Drain Diode Recovery Time Comparable to a Discrete
Fast Recovery Diode
Diode is Characterrized for Use in Bridge Circuits



- 1. Gate
- 2. Drain
- 3. Source

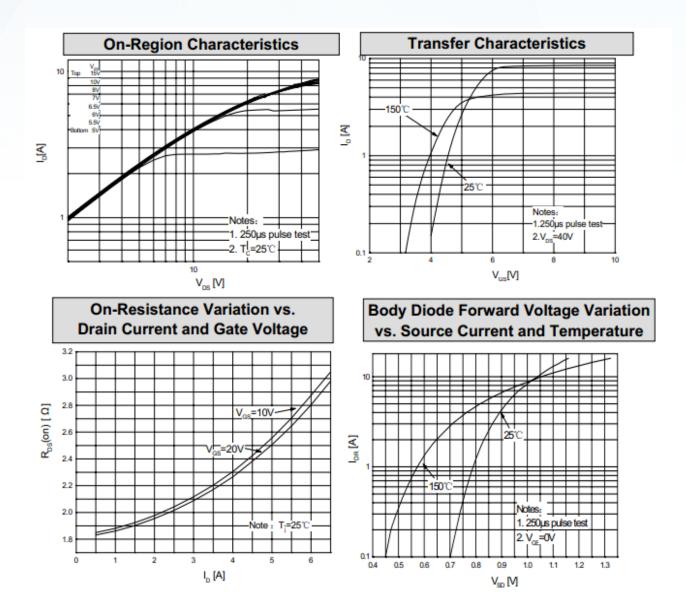
■ MAXIMUM RATINGS (TA=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
VDS	Drain-Source voltage	650	V
Vgs	Gate-Source voltage	±30	V
lo	Drain current-Continuous	4	Α
PD	Maximum Power Dissipation	2	W
Eas	Single pulse avalanche energy	200	mJ
T _J ,Tstg	Operating Junction and Storage Temperature Range	-55-150	$^{\circ}$

■ ELECTRICAL CHARACTERISTICS (Tamb=25°C unless otherwise specified)

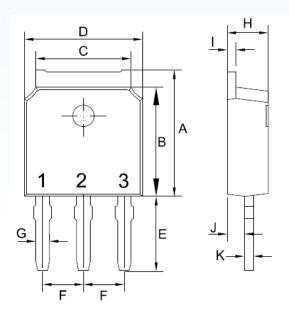
Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	V(BR)DSS	Vgs=0V,ID=250uA	650			V
Zero Gate Voltage Drain Current	IDSS	Vps=650V, Vgs=0V			10	uA
Gate-body Leakage	Igss	Vps=0V, Vgs=±30V			±100	nA
Gate-Threshold Voltage	Vth(GS)	Vps= Vgs, Ip=250 uA	2		4	V
Drain-Source On-Resistance	RDS(ON)	Vgs=10V, ID=2A			2.8	Ω
Diode Forward Voltage(Note3)	VsD	Vgs=0V, ID=4A			1.5	V
Input Capacitance	Ciss			710	920	
Output Capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		65	858	pF
Reverse Transfer Capacitance	Crss			14	19	





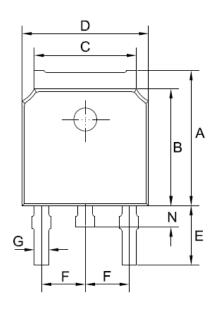


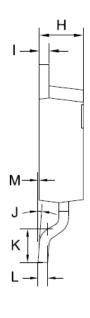
TO-251 Mechanical Drawing



TO-251 (IPAK)			
Unit:mm			
DIM	MIN	MAX	
A	6.85	7. 25	
В	5. 90	6. 30	
С	5. 13	5. 53	
D	6.40	6.80	
E	3. 95	4. 35	
F	2. 19	2. 39	
G	0.45	0.85	
Н	2. 20	2.40	
Ι	0.41	0.61	
J	0.71	1.31	
K	0.41	0.61	

TO-252 Mechanical Drawing





TO-252 (DPAK)			
Unit:mm			
DIM	MIN	MAX	
A	6.85	7. 25	
В	5. 90	6.30	
С	5. 13	5. 53	
D	6.40	6.80	
Е	2.90	3.30	
F	2. 19	2.39	
G	0.45	0.85	
Н	2. 20	2.40	
I	0.41	0.61	
J	0°	8°	
K	1.45	1.85	
L	0.41	0.61	
М	0.00	0.12	
N	0.60	1.00	



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